FAIRCHILD SEMICONDUCTOR®

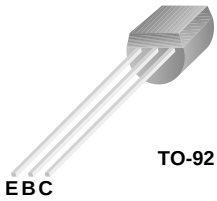
October 2011

2N3906 / MMBT3906 / PZT3906
PNP General Purpose Amplifier

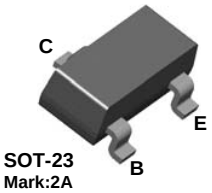
Features

- This device is designed for general purpose amplifier and switching applications at collector currents of 10μA to 100 mA.

2N3906

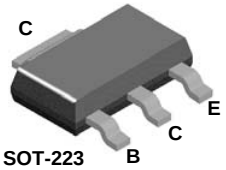


MMBT3906



SOT-23
Mark:2A

PZT3906



SOT-223

Absolute Maximum Ratings* T_a = 25°C unless otherwise noted

Symbol	Parameter	Value	Units
V_{CEO}	Collector-Emitter Voltage	-40	V
V_{CBO}	Collector-Base Voltage	-40	V
V_{EBO}	Emitter-Base Voltage	-5.0	V
I_C	Collector Current - Continuous	-200	mA
$T_{J,}$ T_{stg}	Operating and Storage Junction Temperature Range	-55 to +150	°C

* These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

NOTES:

1) These ratings are based on a maximum junction temperature of 150 degrees C.

2) These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.

Thermal Characteristics T_a = 25°C unless otherwise noted

Symbol	Parameter	Max.			Units
		2N3906	*MMBT3906	**PZT3906	
P_D	Total Device Dissipation Derate above 25°C	625 5.0	350 2.8	1,000 8.0	mW mW/°C
$R_{\theta JC}$	Thermal Resistance, Junction to Case	83.3			°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	200	357	125	°C/W

* Device mounted on FR-4 PCB 1.6" X 1.6" X 0.06".

** Device mounted on FR-4 PCB 36 mm X 18 mm X 1.5 mm; mounting pad for the collector lead min. 6 cm^2.

Electrical Characteristics T_a = 25°C unless otherwise noted

Symbol	Parameter	Test Condition	Min.	Max.	Units
OFF CHARACTERISTICS					
$V_{(BR)CEO}$	Collector-Emitter Breakdown Voltage*	I_C = -1.0mA, I_B = 0	-40		V
$V_{(BR)CBO}$	Collector-Base Breakdown Voltage	I_C = -10μA, I_E = 0	-40		V
$V_{(BR)EBO}$	Emitter-Base Breakdown Voltage	I_E = -10μA, I_C = 0	-5.0		V
I_{BL}	Base Cutoff Current	V_{CE} = -30V, V_{BE} = -3.0V		-50	nA
I_{CEX}	Collector Cutoff Current	V_{CE} = -30V, V_{BE} = -3.0V		-50	nA
ON CHARACTERISTICS					
h_{FE}	DC Current Gain*	I_C = -0.1mA, V_{CE} = -1.0V I_C = -1.0mA, V_{CE} = -1.0V I_C = -10mA, V_{CE} = -1.0V I_C = -50mA, V_{CE} = -1.0V I_C = -100mA, V_{CE} = -1.0V	60 80 100 60 30	300	
$V_{CE(sat)}$	Collector-Emitter Saturation Voltage	I_C = -10mA, I_B = -1.0mA I_C = -50mA, I_B = -5.0mA		-0.25 -0.4	V V
$V_{BE(sat)}$	Base-Emitter Saturation Voltage	I_C = -10mA, I_B = -1.0mA I_C = -50mA, I_B = -5.0mA	-0.65	-0.85 -0.95	V V
SMALL SIGNAL CHARACTERISTICS					
f_T	Current Gain - Bandwidth Product	I_C = -10mA, V_{CE} = -20V, f = 100MHz	250		MHz
C_{obo}	Output Capacitance	V_{CB} = -5.0V, I_E = 0, f = 100kHz		4.5	pF
C_{ibo}	Input Capacitance	V_{EB} = -0.5V, I_C = 0, f = 100kHz		10.0	pF
NF	Noise Figure	I_C = -100μA, V_{CE} = -5.0V, R_S = 1.0kΩ, f = 10Hz to 15.7kHz		4.0	dB
SWITCHING CHARACTERISTICS					
t_d	Delay Time	V_{CC} = -3.0V, V_{BE} = -0.5V I_C = -10mA, I_{B1} = -1.0mA		35	ns
t_r	Rise Time			35	ns
t_s	Storage Time	V_{CC} = -3.0V, I_C = -10mA, I_{B1} = I_{B2} = -1.0mA		225	ns
t_f	Fall Time			75	ns

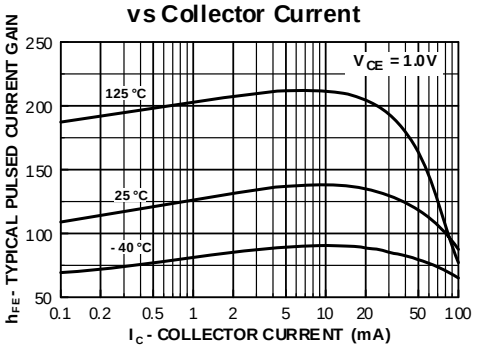
* Pulse Test: Pulse Width ≤ 300μs, Duty Cycle ≤ 2.0%

Ordering Information

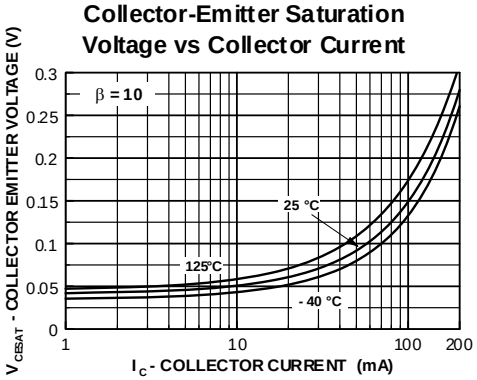
Part Number	Marking	Package	Packing Method	Pack Qty
2N3906BU	2N3906	TO-92	BULK	10000
2N3906TA	2N3906	TO-92	AMMO	2000
2N3906TAR	2N3906	TO-92	AMMO	2000
2N3906TF	2N3906	TO-92	TAPE REEL	2000
2N3906TFR	2N3906	TO-92	TAPE REEL	2000
MMBT3906	2A	SOT-23	TAPE REEL	3000
PZT3906	3906	SOT-223	TAPE REEL	2500

Typical Performance Characteristics

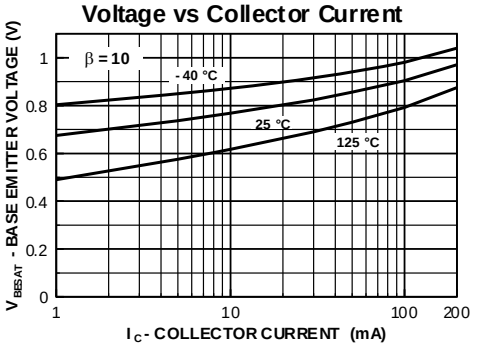
Typical Pulsed Current Gain vs Collector Current



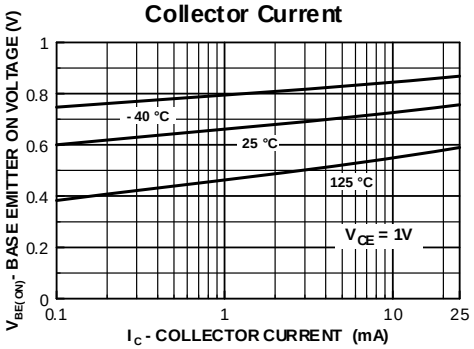
Collector-Emitter Saturation Voltage vs Collector Current



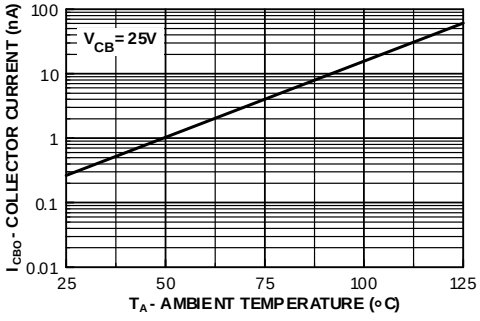
Base-Emitter Saturation Voltage vs Collector Current



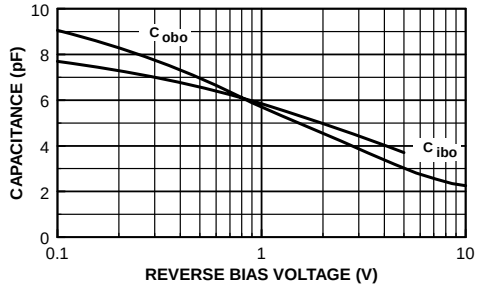
Base Emitter ON Voltage vs Collector Current



Collector-Cutoff Current vs Ambient Temperature

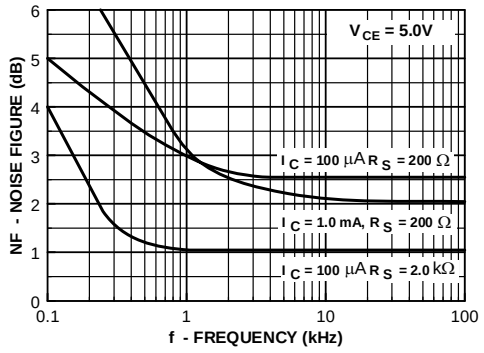


Common-Base Open Circuit Input and Output Capacitance vs Reverse Bias Voltage

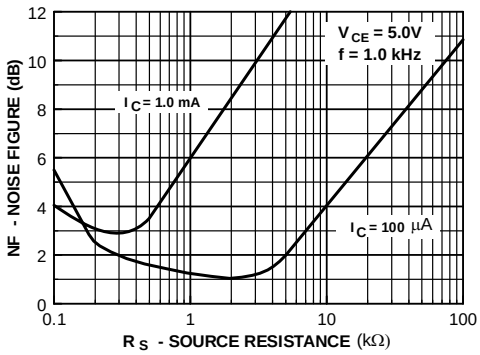


Typical Performance Characteristics (continued)

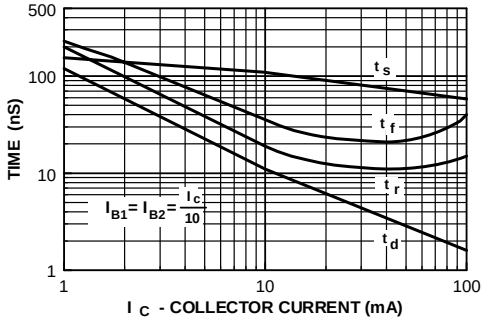
Noise Figure vs Frequency



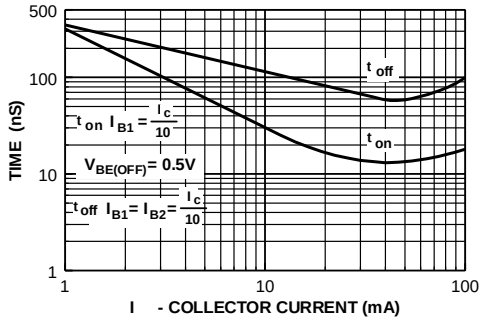
Noise Figure vs Source Resistance



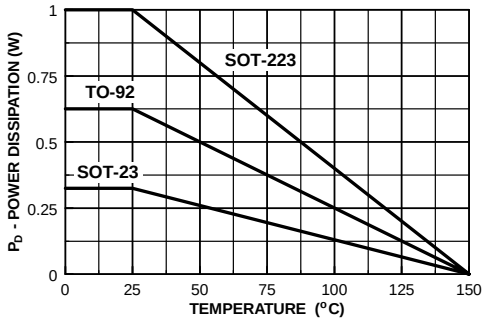
Switching Times vs Collector Current



Turn On and Turn Off Times vs Collector Current

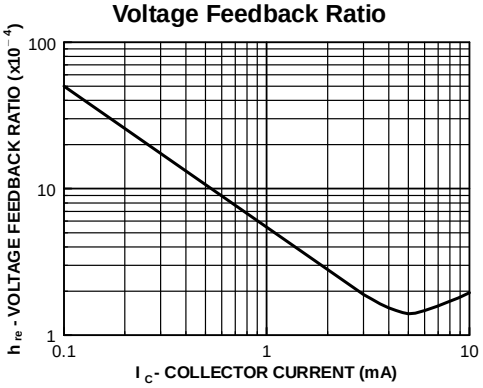


Power Dissipation vs Ambient Temperature

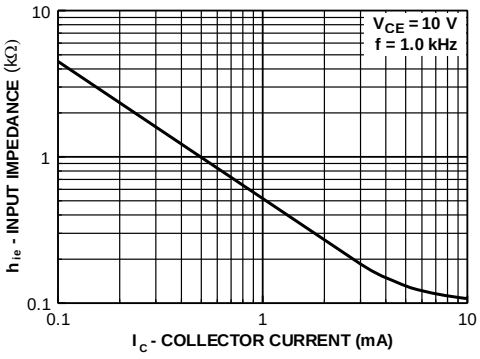


Typical Performance Characteristics (continued)

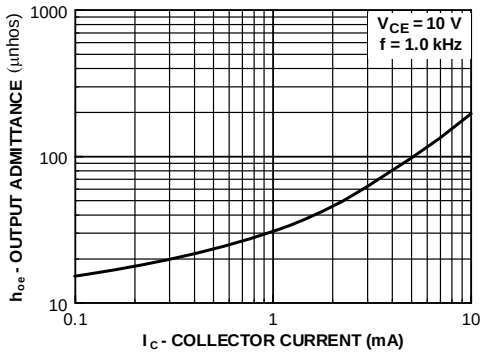
Voltage Feedback Ratio



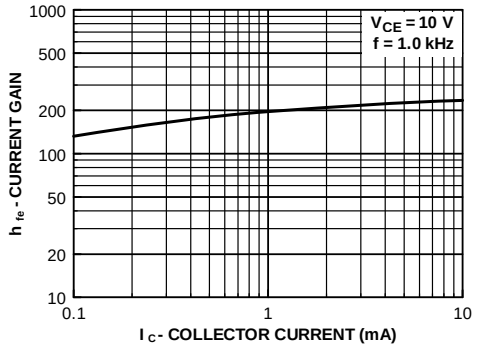
Input Impedance



Output Admittance



Current Gain



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